## 915MHz, 450W, 40V High Power RF LDMOS FETs

### Description

The ITDE10450C2 is a 450-watt, internally matched LDMOS FET, designed for ISM applications including RF Energy at 915MHz. It Can be used in Class AB/B and Class C configuration, supporting both CW and pulsed signal

In typical application using 2\*ITDE10450C2 in parallel, it can deliver more than 850W CW with high efficiency

•Typical Performance using single **ITDE10450C2** (On Innogration fixture with device soldered): VDD = 40 Volts, I<sub>DQ</sub> = 50 mA, CW signal

Freq(MHz)	Pin(dBm)	Pout(dBm)	Pout(W)	IDS(A)	Gain(dB)	EFF(%)
915	40	56.7	470	16.7	16.7	70.0%

• Typical Performance using ITDE10450C2\*2 (On Innogration fixture with device soldered):

VDD = 40 Volts, I<sub>DQ</sub> = 50 mA, CW signal

Freq(MHz) Pin(dBm)		Pout(dBm)	Pout(W)	IDS(A)	Gain(dB)	EFF(%)
915	43	59.5	880	34.5	16.5	64.0%

### Features

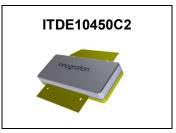
- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Internally Matched for Ease of Use
- Excellent thermal stability, low HCI drift

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

#### Table 1. Maximum Ratings

Rating	Symb	ol	,	Value		Unit
DrainSource Voltage	V <sub>DSS</sub>			95		Vdc
GateSource Voltage V <sub>G</sub>			-10 to +10			Vdc
Operating Voltage	V <sub>DD</sub>		+42			Vdc
Storage Temperature Range	Tstg		-65	to +150		°C
Case Operating Temperature	Tc			+150		°C
Operating Junction Temperature	TJ			+225		°C
Table 2. Thermal Characteristics						
Characteristic	Symb	ol	,	Value		Unit
Thermal Resistance, Junction to Case	Devi			0.0		°C/W
$T_{C}$ = 85°C, $T_{J}$ =200°C, DC test	Rejo	<b>ΧθJC</b> 0.3		0.3	°C/	
Table 3. ESD Protection Characteristics						
Test Methodology				Class		
Human Body Model (per JESD22A114)		Class 2				
Fable 4. Electrical Characteristics (TA = 25 C units)	nless otherwise note	ed)				
Characteristic		Symbol	Min	Тур	Max	Unit

DC Characteristics (per half section)



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Drain-Source Breakdown Voltage	V <sub>DSS</sub>	95			V
(V <sub>GS</sub> =0V; I <sub>D</sub> =100uA)	V DSS	90			v
Zero Gate Voltage Drain Leakage Current				10	
(V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V)	DSS			10	μΑ
GateSource Leakage Current				1	
(V <sub>GS</sub> = 6 V, V <sub>DS</sub> = 0 V)	I <sub>GSS</sub>				μΑ
Gate Threshold Voltage	M (the)		2.0		V
(V <sub>DS</sub> = 40V, I <sub>D</sub> = 600 uA)	V <sub>GS</sub> (th)		2.0		V
Gate Quiescent Voltage	V	2.1	2.62	3.1	V
$(V_{DD}$ = 40 V, $I_{DQ}$ = 100 mA, Measured in Functional Test)	$V_{GS(Q)}$	2.1	2.02	3.1	v

Functional Tests (On Innogration Test Fixture, 50 ohm system) :  $V_{DD}$  =40 Vdc,  $I_{DQ}$  = 50 mA, f = 915 MHz, Pin=40dBm CW Signal Measurements.

Power Gain	Gp		16.5		dB
Drain Efficiency @ P <sub>OUT</sub>	$\eta_{D}$		70		%
Output Power	P <sub>out</sub>		450		W
Input Return Loss	IRL		-7		dB
Load Mismatch (In Innogration Test Fixture, 50 ohm system): V <sub>DD</sub> = 40 Vdc, I <sub>DQ</sub> = 50 mA, f = 915 MHz					

VSWR 10:1 at 450W Output Power	No Device Degradation
at all Phase Angles, pulsed CW, 100us, 10%	

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Reference Circuit of Test Fixture Assembly Diagram 1\*ITDE10450C2

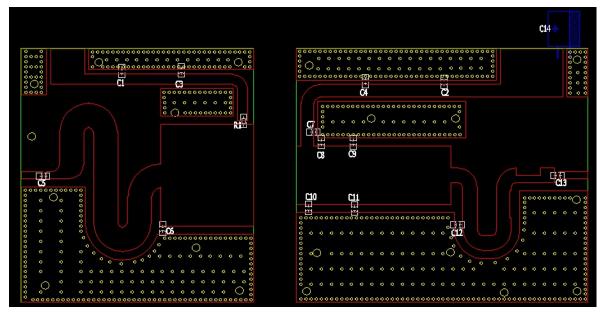
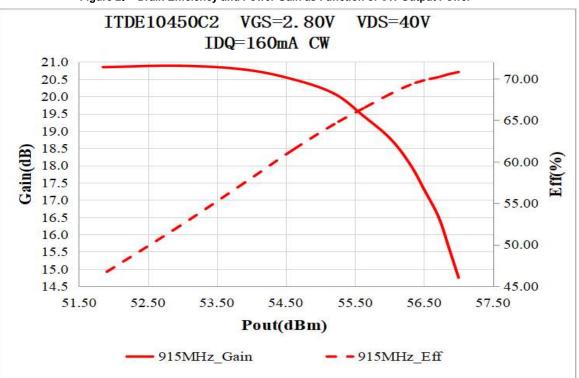


Figure 1. Test Circuit Component Layout

#### Table 1. Test Circuit Component Designations and Values

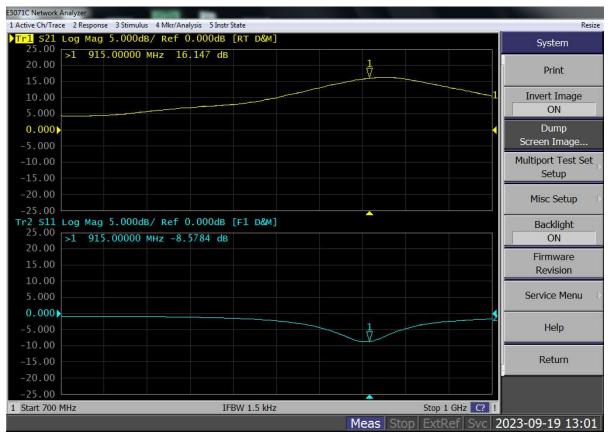
Component	Description	Suggestion
C1,C2	10Uf	10Uf/100V
C3,C4,C5	56Pf	MQ101111
C6	7.5Pf	MQ101111
C14	2000Uf/63V	Electrolyic Capacitor
R1	10 Ω	Chip Resistor
C7	9.1Pf	MQ101111
C8	12Pf	MQ101111
C9	8.2Pf	MQ101111
C10	11Pf	MQ101111
C11	10Pf	MQ101111
C12	0.5Pf	MQ101111
C13	47Pf	MCM-1-300V-D-470J
РСВ	30mil	Rogers 4350B



## **TYPICAL CHARACTERISTICS**

Figure 2. Drain Efficiency and Power Gain as Function of CW Output Power





## Reference Circuit of Test Fixture Assembly Diagram 2\*ITDE10450C2

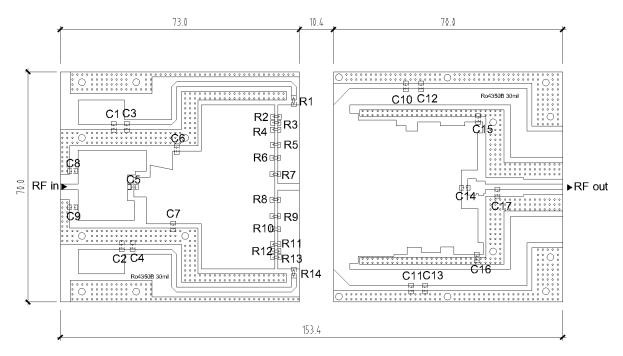


Figure 3. Test Circuit Component Layout

Component	Description	Suggested Types
C1、C2、C5、C10、C11	56Pf	ATC800B
C14	56Pf*3	ATC800B
C3、C4、C12、C13	Ceramic multilayer capacitor, 10Uf	
C6	3.3Pf	ATC800B
C7	5.6Pf	ATC800B
C8	3.3Pf	ATC800B
С9	1Pf	ATC800B
C15、C16、C17	0.5Pf	ATC800B
R1~R14	Chip Resistor,9.1Ω,1206	
РСВ	30mil thickness,RO4350B	

## **TYPICAL CHARACTERISTICS**



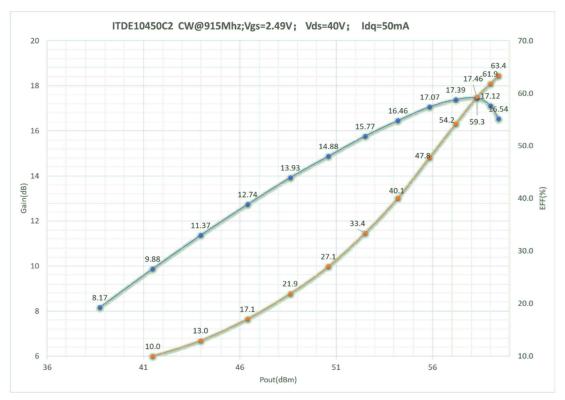
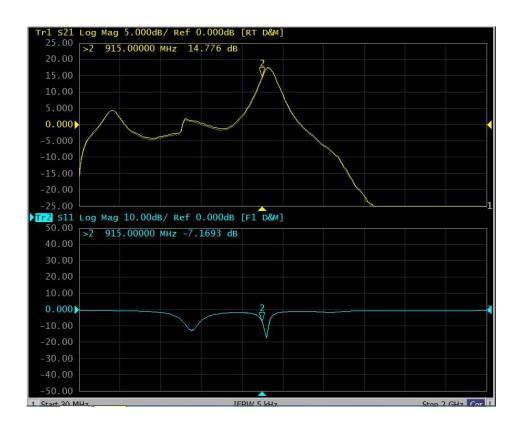
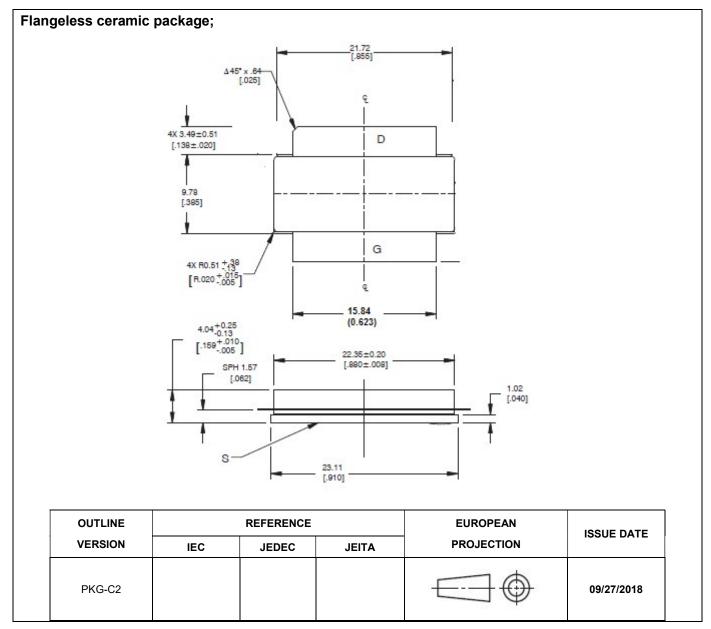


Figure 3. Network analyzer output S11/S21



## Package Outline



### **Revision history**

#### Table 6. Document revision history

Date	Revision	Datasheet Status
2022/1/12	Rev 1.0	Preliminary Datasheet
2023/9/19	Rev 1.1 Add single device application data	
2023/10/20	Rev 1.2	Modify the error of thermal resistor and product rating on page 1 and 2

Application data based on JF-21-14/TC-23-60

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